



## CMS Silicon Strip Tracker Performance

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# **CMS Silicon Strip Tracker**

- 2.4m diameter, 5.5m long, 198m<sup>2</sup>, 15148 modules,
  9.3 million channels, in a 3.8T solenoïd
- must provide low occupancy, fast readout, high precision, radiation hardness
- double sided layers : stereo angle of 100 mrad (5.7 deg)









## Modules



- \* sensors of p+ strips on n-bulk, thickness of 320 and 500 μm
- \* 15 types of sensors, 512 or 768 strips, pitch 80-205 μm
- \* pitch depend of R : keep low occupancy and good resolution
- analogue readout







### Readout

APV

module



APV25 chip :

- pre-amplification
- \* fast shapping :
  - Peak mode : rise time of 50 ns, 1 sample
  - Deconvolution mode :
    - standard mode in collision
    - combine 3 samples, shorter pulse
    - needed but more sensitive to timing and reduced S/N
  - 2 shaper parameters tuned to give expected rise time and shape close to ideal RC-CR curve
- Send information of 128 strips in an analogue frame





#### Off-detector Front-End Controller (FEC)

- send clock, L1 triggers, slow control commands
- time adjustement
  - Synchronization of all modules to each other, looking at tick mark sent every 35 LHC clock

Timing

- global latency scan by steps of 25ns, synchronize tracker to central trigger
- fine delay scan by steps of 1ns
  - per detector layer
  - delay corrected for time of flight
- mis-timing of 5 ns would give ~6% less signal in TOB











# Signal treatment





- \* Data sent via optic link to Front End Driver (FED) processing board
  - laser tuned to optimize ADC range
- \* FED digitize signal and apply Zero Suppression
  - analogue baseline level tuned for a MIP signal at 1/3 of ADC range
  - special runs in absence of signal to measure pedestal and noise for each strip
  - Noise depends on strip length, temperature
  - calibration each times conditions have changed (hardware, temperature)



### Gain calibration



#### tick mark calibration

- First calibration using tick mark height and tuning it to 640 ADC counts
  - does not take into account differences at the sensor level

#### particle calibration

- use path length corrected on-track cluster charge
- normalize to 300 ADC counts/mm : expected value for MIP with calibration of 270e-/ADC count





#### Clusters and hits



Cluster from 3 thresholds algorithm :

- seeded from strips with charge > 3 times the strip noise
- add neighbours with charge > 2 times the strip noise
- cluster kept if charge > 5 times cluster noise (quad. sum of strips noise)
- need of strip noise value
- Hit : cluster with associated position and errors
  - position from centroid of strips signal height
  - corrected from magnetic field effect

#### Lorentz Angle



ield, direction Due to m \* is tilted by the of charge calmers Lorentz angle Ε maximal effect in barrel :  $B \perp E$ \*



- Systematic shift in cluster position \*
- Study cluster width versus particle \* crossing angle
- Minimum cluster width for Lorentz \* angle

	tan $\Theta_L$	δx	
TIB	0.07±0.02	~I0µm	
TOB	0.09±0.01	01 ~20µm	

: 
$$\delta x_{\text{cluster}} = \frac{t}{2} \cdot \tan \Theta_L$$





# Charge collection



- S/N : important variable for monitoring of tracker, done run by run
- computed from on-track clusters corrected for path lenght
- thick sensors collect more than thin



	TIB	TID	ТОВ	TEC+ thin	TEC+ thick
MPV	19.4	18.5	22.5	19.4	23.9



#### Module efficiency



- 98.1% of channels in operation
- For active channels : 99.8% efficiency
  - measured from high purity tracks
  - tracking without the layer studied
  - module crossed should contain a hit
- Done at module level, once per week, useful to spot problems





### Hit resolution



- reconstruct track without the layer considered
- Use overlapping modules
- Distance between 2 hits less sensitive to track extrapolation, interactions with material
- \* Compare  $\Delta x_{hit}$  to  $\Delta x_{pred}$
- Resolution depends of strip length, pitch, particle incidence angle











- Wide linear range that provide energy loss measurement
- use protons in 0.7-1.0 GeV/c range to fit :  $\frac{dE}{dx} = K \frac{m^2}{p^2} + C$
- From parameters can extract mass spectrum : D peak visible (not in Pythia)
- \* used for search of heavy stable charged particles, reconstruction of low mass resonances giving charge hadrons ( $Φ→K^+K^-$ )





# Tracking performance



- Basic track distributions : good data/simulation agreement
- Reconstruction of resonances with good precision :
  - $K^0_S \rightarrow \pi\pi$ ,  $\Lambda^0 \rightarrow p\pi$ ,  $K^*(892)^{\pm} \rightarrow K^0_S\pi$ ,  $\Xi^{\pm} \rightarrow \Lambda^0\pi$ ,  $\Sigma(1385)^{\pm} \rightarrow \Lambda^0\pi$ ,  $\Xi(1530)^0 \rightarrow \Xi\pi$ • The dip at the ~ -1.5 gets much smalle  $\Im_{70000}^{\bullet}$
  - $\Phi(1020) \rightarrow KK , D^0 \rightarrow K\pi ,$  $D^* \rightarrow D^0 \pi^*, D^{200} \rightarrow K\pi\pi , \Omega^- \rightarrow \Lambda^0 K$
- Reconstruction of conversion and nuclear interactions







### Conclusion



- Largest silicon tracker ever build
- Well calibrated and understood
- Efficient operation and excellent performance
- Allows good tracking, vertexing and physics analyses



#### Detector monitoring



- Express Stream
  - First reco of data, within 2 hours after run end
    - a part of triggers only
    - used for online and first offline DQM
    - use masks taking into account hardware cabling
- Prompt Reco
  - First reco of all data, within 48 hours
  - Delay allows to use masking of strips and modules from a noisy channel analysis on run by run basis
  - Used for runs certification
- \* Other checks on regular basis :
  - spy channels : possibility to read data from FED before ZS
  - bias HV scan : to study evolution with radiation dose

SiStrip Report for Good Detector Fraction

SiStrip Report for Signal-to-Noise







# Alignment



- track-based algorithms
  - Millepede II : global method, simultaneous fit of alignment parameters
  - Hit and Impact Point (HIP) : local approach, look at each module separately, large number of iterations for big misalignment
  - Used both in sequence
  - use cosmics (vertical tracks well suited for barrel) and collision events
- Validation looking at χ<sup>2</sup> of tracks, track-to-hits and track-to-vertex residuals
- Start to take into account bowing of sensors, kink between 2 sensors on same module



Distribution of Median of Residuals

from hits

